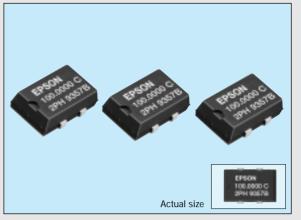
Crystal oscillator

PROGRAMMABLE HIGH-FREQUENCY CRYSTAL OSCILLATOR

- Wide frequency output by PLL technology.
- Quick delivery of samples and short lead mass production time.
- Excellent shock resistance and environmental capability.
- Output enable function (OE) and stand-by function (ST) can be used for low current consumption applications.
- Package and pin compatible with SG-615.

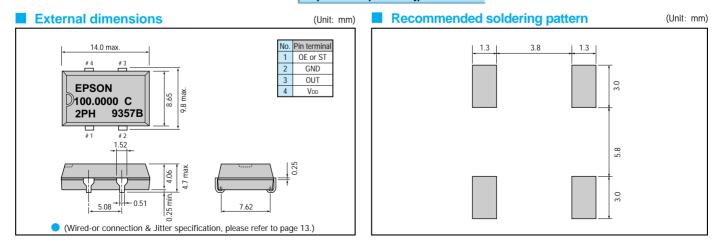
8002 PROM Writer available to purchase.(Type:PRW-8000A3-M01) Please contact EPSON or local sales representative.



Specifications (characteristics)

_			-				
Item		Symbol	PT/ST	PH/SH	PC/SC	Remarks	
			Specifications				
Output frequency range		fo		1.0000 MHz to 125.0000 MHz			
Power source	Max. supply voltage	VDD-GND		-0.5V to +7.0V			
voltage	Operating voltage	Vdd	5.0V±0.5V		3.3 ± 0.3V	3.0V ±0.3V: f ₀ ≤ 66.7MHz(PC/SC)	
Temperature range	Storage temperature	Tstg	-55°C to +125°C				
	Operating temperature	Topr	-20°C to +70°C (-4	0°C to +85°C)	-40°C to +85°C	Refer to page 4."Frequency range"	
Soldering condition		Tsol	Twice at under 260°C within 10 sec. or under 230°C within 3 min.				
Frequency stability		Δ f/fo	B: ±50ppm C: ± 100ppm M: ±100ppm(-40°C to +85°C)		-20°C to +70°C		
Current consumption		lop	45mA max. 28mA max.		No load condition, Max. frequency range		
Output disable current		IOE	30mA max.		16mA max.	OE=GND(PT, PH, PC)	
Standby current		lsт		50µA max.		ST=GND(ST, SH, SC)	
Duty		tw∕ t			C-MOS load: 1/2VDD level		
			40% to 60%		_	TTL load: 1.4V level	
High output voltage		Vон		VDD -0.4V min.		Iон=-16mA(PT/ST, PH/SH),-8mA(PC/SC)	
Low output voltage		Vol		0.4V max.		I₀⊾= 16mA(PT/ST, PH/SH), 8mA(PC/SC)	
Output load TTL		Ν	5TTL max.			Max. frequency and max. operating voltage range	
condition (fan out)	C-MOS	CL	15pF max.	25pF max.	15pF max.	wax. frequency and max. operating voltage range	
Output enable/disable input voltage		VIH	2.0V r	nin.	$0.7 \times V_{DD}$ min.	- ST, OE terminal	
		VIL	0.8V r	nax.	$0.2 \times V_{DD}$ max.		
Output rise time	C-MOS level	. –		4ns max.		C-MOS load: 20%→80% VDD	
	TTL level	tтьн	4ns max.			TTL load: 0.4V→2.4V	
Output fall time	C-MOS level	tтнL	—	4ns max.		C-MOS load: 80%→20% VDD	
	TTL level	LTHL	4ns max.			TTL load: 2.4V→0.4V	
Oscillation start up time		tosc		10ms max.		Time at minimum operating voltage to be 0 sec.	
Aging		fa	±5ppm/year max.		Ta= 25°C, V _{DD} = 5.0V/3.3V(PC/SC)		
Shock resistance		S.R.		±20ppm max.		Three drops on a hard board from 75 cm or excitation test with 3000G x 0.3ms x 1/2sine wave in 3 directions	

Note: • Please contact us for inquiries about operating temperature(-40°C to +85°C), usable frequencies, duty and output load conditions. Checking possible by the Frequency Checking Program. http://www.epson.co.jp/CRYSTAL/



THE CRYSTALMASTER



ENERGY SAVING EPSON

Resource

Saving

EPSON offers effective savings to its customers through a wide range of electronic devices, such as semiconductors, liquid crystal display (LCD) modules, and crystal devices. These savings are achieved through a sophisticated melding of three different efficiency technologies.

Power saving technology provides low power consumption at low voltages.

Space saving technology provides further reductions in product size and weight through super-precise processing and high-density assembly technology.

Time saving technology shortens the time required for design and development on the customer side and shortens delivery times.

Energy Saving
Power Saving
Space Saving
Time Saving

Our concept of Energy Saving technology conserves resources by blending the essence of these three efficiency technologies. The essence of these technologies is represented in each of the products that we provide to our customers.

In the industrial sector, leading priorities include measures to counter the greenhouse effect by reducing CO2,

measures to preserve the global environment, and the development of energy-

efficient products. Environmental problems are of global concern, and although the contribution of energysaving technology developed by EPSON may appear insignificant, we seek to contribute to the develop-

ment of energy-saving products by our customers through the utilization of our electronic devices. EPSON is committed to the conservation of energy, both for the sake of people and of the planet on which we live.





SEIKO EPSON CORP. QUARTZ DEVICE DIVISION acquired ISO9001 and ISO14001 certification by B.V.Q.I. (Bureau Veritas Quality International).

ISO9001 in October, 1992.

ISO14001 in November, 1997.

NOTICE

No part of this material may be reproduced or duplicated in any form or by any means without the written permission of Seiko Epson. Seiko Epson reserves the right to make changes to this material without notice. Seiko Epson does not assume any liability of any kind arising out of any inaccuracies contained in this material or due to its application or use in any product or circuit and, further, there is no representation that this material is applicable to products requiring high level reliability, such as, medical products. Moreover, no license to any intellectual property rights is granted by implication or otherwise, and there is no representation or warranty that anything made in accordance with this material will be free from any patent or copyright infringement of a third party. This material of portions there may contain technology or the subject relating to strategic products under the control of the Foreign Exchange and Foreign Trade Control Law of Japan and may require an export license from the Ministry of International Trade and Industry or other approval from another government agency.